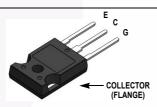
May 2014



FGH40T65SHDF 650 V, 40 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature : T_J = 175^oC
- Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.45 V (Typ.) @ I_C = 40 A
- + 100% of the Parts tested for $I_{LM}(1)$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- RoHS Compliant

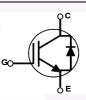


General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer superior conduction and switching performance and easy parallel operation. This device is well suited for the resonant or soft switching application such as induction heating and MWO.

Applications

Induction Heating, MWO



Absolute Maximum Ratings

Symbol	Description		FGH40T65SHDF_F155	5 Unit
V _{CES}	Collector to Emitter Voltage		650	V
V _{GES}	Gate to Emitter Voltage		± 20	V
	Transient Gate to Emitter Voltage	± 30	V	
I _C	Collector Current	@ T _C = 25 ^o C	80	A
10	Collector Current	@ T _C = 100°C	40	A
I _{LM} (1)	Pulsed Collector Current	@ T _C = 25°C	120	A
I _{CM} (2)	Pulsed Collector Current		120	A
I _F	Diode Forward Current	@ T _C = 25°C	40	A
	Diode Forward Current	@ T _C = 100°C	20	A
I _{FM}	Pulsed Diode Maximum Forward Current		60	A
P _D	Maximum Power Dissipation	@ T _C = 25°C	268	W
. D	Maximum Power Dissipation	@ T _C = 100°C	134	W
TJ	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 120 A, R_G = 30 Ω , Inductive Load 2. Repetitive rating: Pulse width limited by max. junction temperature

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V, 40 A Field Stop Trench IGBT
IGBT

Symbol	Parameter	FGH40T65SHDF_F155	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.56	°C/W
R _{θJC} (Diode)	Thermal Resistance, Junction to Case, Max.	1.75	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Qty per Tube
FGH40T65SHDF	FGH40T65SHDF_F155	TO-247 G03	-	-	30

Electrical Characteristics of the IGBT T_c = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	-	0.6	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
I _{GES}	G-E Leakage Current	V_{GE} = V_{GES} , V_{CE} = 0 V	-	-	± 400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 40 mA, V _{CE} = V _{GE}	3.5	5.5	7.5	V
()		I _C = 40 A, V _{GE} = 15 V	-	1.45	1.81	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$	-	1.8	-	V
Dynamic C	Characteristics					
C _{ies}	Input Capacitance		-	1982	-	pF
C _{oes}	Output Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	70	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1 MHz	-	25	-	pF
Switching	Characteristics					
T _{d(on)}	Turn-On Delay Time		-	18	-	ns
T _r	Rise Time		-	27	-	ns
T _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 40 A,	-	64	-	ns
T _f	Fall Time	$R_{G} = 6 \Omega, V_{GE} = 15 V,$	-	3	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	1.22		mJ
E _{off}	Turn-Off Switching Loss		-	0.44	-	mJ
E _{ts}	Total Switching Loss		-	1.66	-	mJ
T _{d(on)}	Turn-On Delay Time		-	18	-	ns
T _r	Rise Time		-	31	-	ns
T _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 40 A,	-	70	-	ns
T _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	56	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 175 ^o C	-	1.78	-	mJ
-011		=	-	1	-	
E _{off}	Turn-Off Switching Loss		-	0.78	-	mJ

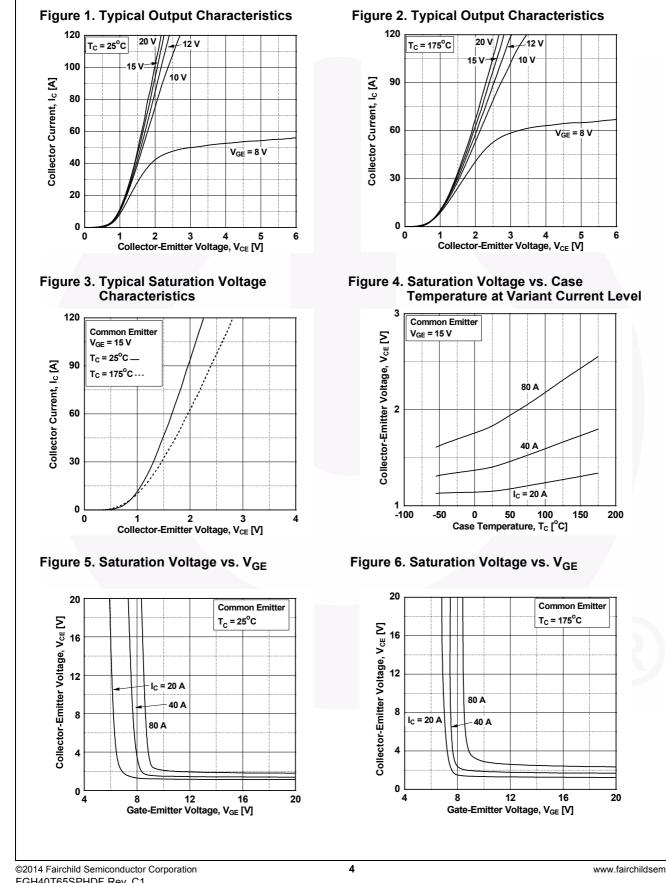
Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	68	-	nC
Q _{ge}	Gate to Emitter Charge		-	12	-	nC
Q _{gc}	Gate to Collector Charge		-	25	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

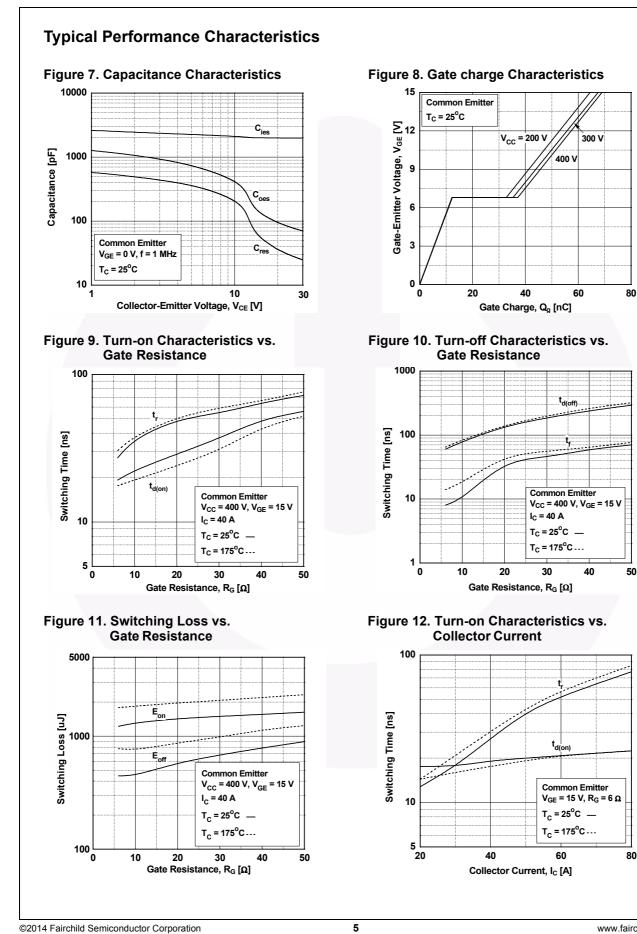
Symbol	Parameter		Test Condition	ns	Min.	Тур.	Max.	Unit
V _{FM}	Diode Forward Voltage	I_ =	20 A	T _C = 25 ^o C	-	1.5	1.95	V
- FINI		1F - 20 A		T _C = 175 ^o C	-	1.37	-	
E _{rec}	Reverse Recovery Energy			T _C = 175 ^o C	-	153	-	μJ
T _{rr}	Diode Reverse Recovery Time	I- =	20 A, dI _F /dt = 200 A/µs	T _C = 25 ^o C		101	-	ns
· II		η <u>-</u>	F = 20 Λ, αιρ/αι = 200 Λ/μ3	T _C = 175 ^o C	-	238	-	
Q _{rr}	Diode Reverse Recovery Charge			T _C = 25 ^o C	-	343	-	nC
	2.000 Hororor (000 vory charge			T _C = 175 ^o C	-	1493	-	

FGH40T65SHDF — 650 V, 40 A Field Stop Trench IGBT



Typical Performance Characteristics

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FGH40T65SPHDF Rev. C1

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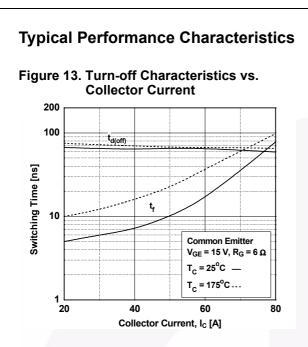


Figure 15. Load Current Vs. Frequency

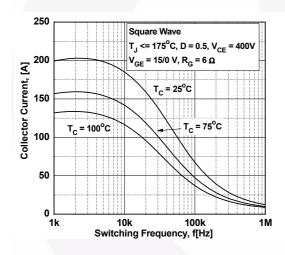
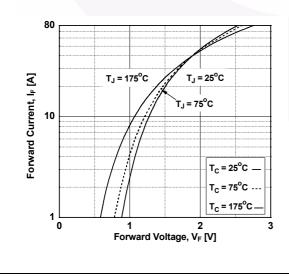


Figure 17. Forward Characteristics



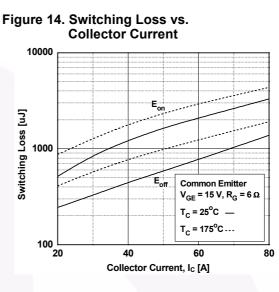


Figure 16. SOA Characteristics

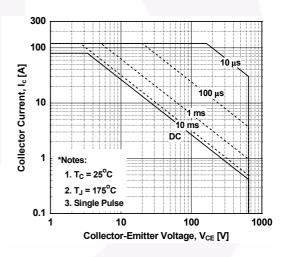
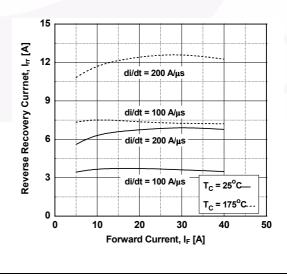
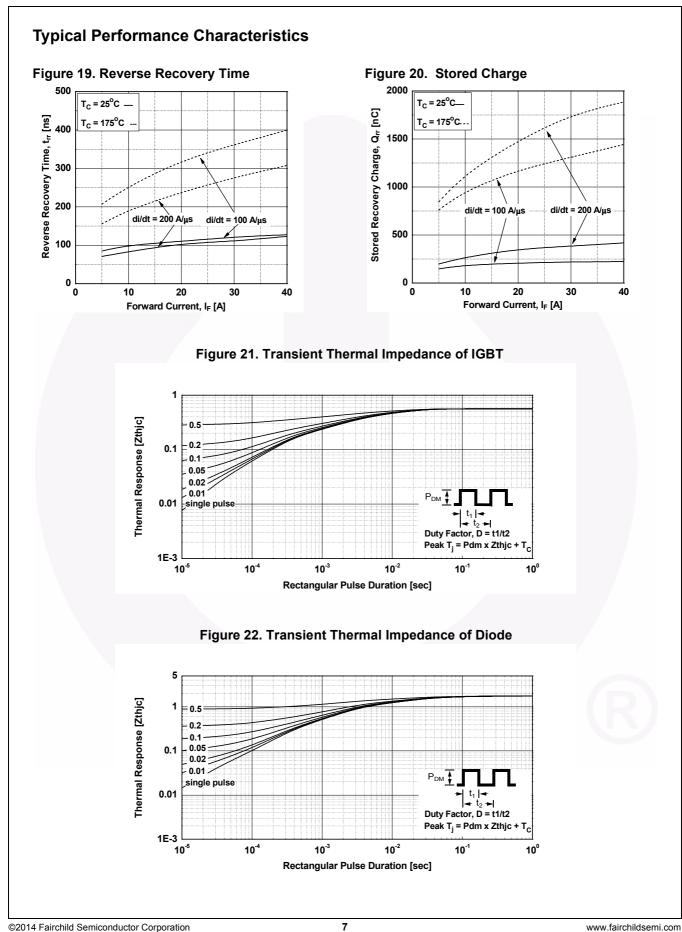


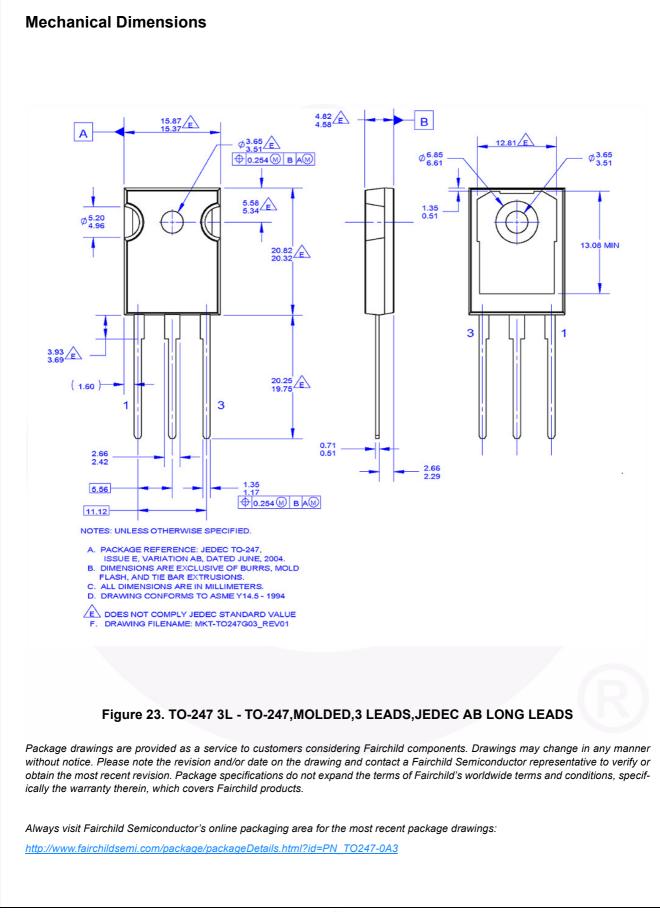
Figure 18. Reverse Recovery Current





FGH40T65SPHDF Rev. C1

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